			F	First Edition Jul 3, 2002
OPTREX	LCD Modu	ule Techni	cal Specification	Final Revision
Type No	C-51505N	IFQJ-LG-A	NF	
1. 2. 3. 4. 5. 6. 7. 8. 9. 10 11	Electrical Specification Optical Specifications I/O Terminal Test Appearance Standards Code System of Produ Type Number Applying Precautions . Precautions Relating	ns uction Lot Product Handling	Approved by (Production Checked by (Quality Assu- Checked by (Design Engin Prepared by (Production E K. Wague	m_{i} yru rance Div.) reering Di
Rev.	Date	Page Com	iment	
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1.General Specifications

Operating Temp.	:	min20°C ~	max. 70°C	
Storage Temp.	:	min20°C ~	max. 70°C	
Display Format	:	20 characters	s × 2 lines	
Display Fonts	:	5 × 8 dots	(1 character)	
Viewing Area	:	83.0 (W) × 1	8.6 (H) mm	
Outline Dimensions	:	116.0 (W) ×	37.0 (H) × (15.6) (D) mm	
Weight	:	42.9g max.		
LCD Type	:		mode / Transmissive)	
Viewing Angle	:	6:00		
Data Transfer	:	8-bit parallel o	data transfer	
Backlight	:	LED Backligh	it / Green	
Additional Spec	:		splay Specification ance Color Film is Used)	
Drawings	:	Dimensional (Outline UE-311044	
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2.Electrical Specifications

2.1. Absolute Maximum Ratings

					Vss=0V
Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	Vcc-Vss	-	-0.3	7.0	V
(Logic)					
Supply Voltage	Vcc-Vee	-	-0.3	13.5	V
(LCD Drive)					
Input Voltage	Vi	-	-0.3	Vcc+0.3	V

2.2. DC Characteristics

Ta=25°C, Vcc=5V, Vss=Vee=0V

				,	00-01,100	-
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage	Vcc-Vss	-	4.5	-	5.5	V
(Logic)						
Supply Voltage	Vcc-Vee		Shown in 3	.1		V
(LCD Drive)						
High Level	Vін	-	2.2	-	Vcc	V
Input Voltage						
Low Level	Vil	-	-0.3	-	0.8	V
Input Voltage						
High Level	Vон	Іон=-0.25mA	2.4	-	-	V
Output Voltage						
Low Level	Vol	loL=1.2mA	-	-	0.4	V
Output Voltage						
Supply Current	lcc	Vcc-Vss=5.3V	-	2.0	3.0	mA

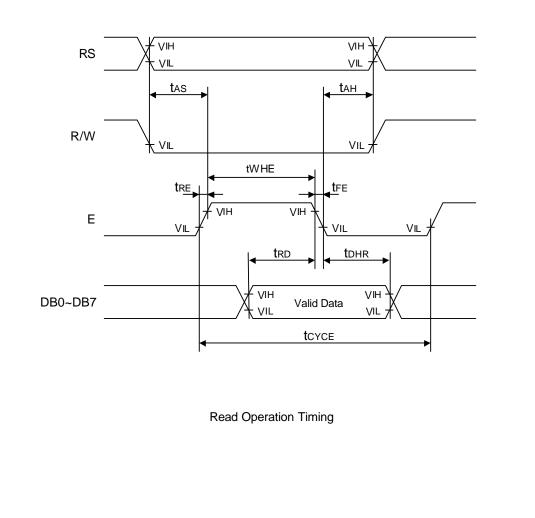
All voltage values are referenced to Vss =0V

 $V_1 \text{ to } V_5 \text{ must maintain } V_{DD} \geq V_1 \geq V_2 \geq V_3 \geq V_4 \geq V_5.$

2.3.AC Characteristic

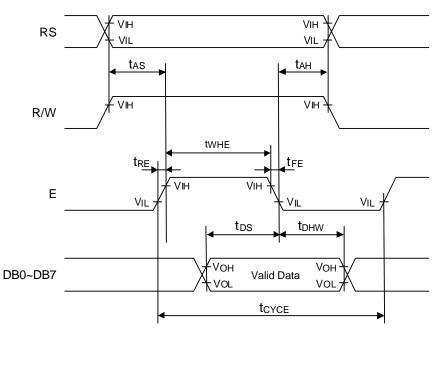
Read Operation

			Vcc=	5.0V±10%
Parameter	Symbol	Min.	Max.	Units
Enable Cycle Time	t _{CYCE}	500	-	ns
Enable "H" Level Pulse Width	t _{whe}	300	-	ns
Enable Rise/Fall Time	$\mathbf{t}_{RE}, \mathbf{t}_{FE}$	-	25	ns
RS,R/W Setup Time (8-bit operation mode) (4-bit operation mode)	t _{AS}	60 100	-	ns
RS,R/W Address Hold Time	t _{AH}	10	-	ns
Read Data Output Delay	t _{RD}	-	190	ns
Read Data Hold Time	t _{DHR}	20	-	ns



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Write Operation				
		T	Vcc=	5.0V±10%
Parameter	Symbol	Min.	Max.	Units
Enable Cycle Time	t _{CYCE}	500	-	ns
Enable "H" Level Pulse Width	twhe	300	-	ns
Enable Rise/Fall Time	t _{re,} t _{re}	-	25	ns
RS,R/W Setup Time (8-bit operation mode)	t _{AS}	60	_	ns
(4-bit operation mode)	4.0	100		110
RS,R/W Address Hold Time	t _{AH}	10	-	ns
Data Output Delay	t⊳s	-	-	ns
Data Hold Time	t _{DHR}	10	-	ns



Write Operation Timing

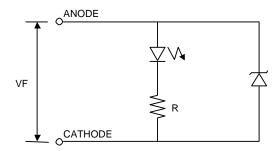
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2.4. Lighting Specifications

2.4.1. Absolute Maximum Ratings

	-					Ta=25°C
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Forward Voltage	VF	Note 1	-	-	6.0	V
LED Power Dissipation	PD	-	-	-	0.125	mW
Reverse Voltage	Vr	-	-	-	5.0	V

Note 1 : VF is defined as the voltage between ANODE and CATHODE as shown below.



2.4.2. Operating Characteristics

Ta=25°C

						10-20 0
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	lF	VF=5.0V	-	15	18	mA
Luminance of	L	VF=5.0V	160	-	-	cd/m ²
Backlight Surface						

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3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta= -20°C	-	-	5.5	V
LCD Driving Voltage	Vcc-Vee	Ta=25°C	4.9	5.3	5.5	V
Note 1		Ta=70°C	4.7	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/16 Duty, 1/5 Bias, Vod=5.5V (Note 4), θ= 0°C, φ=-°

Parameter Symbol		Conditions	Min.	Тур.	Max.	Units	
Contrast Ra	atio Note 1	CR	θ = 0°C , ϕ =-°	-	80	-	
Viewing Angle Shown in 3.3							
Response	Rise Note 2	Τον	-	-	45	90	ms
Time	Decay Note 3	TOFF	-	-	200	300	ms
Note 1 : Contrast ratio is definded as follows (CR $- 1 \text{ on } / 1 \text{ ore}$)							

Note 1 :Contrast ratio is definded as follows. (CR = LON / LOFF)

LON : Luminance of the ON segments

LOFF: Luminance of the OFF segments

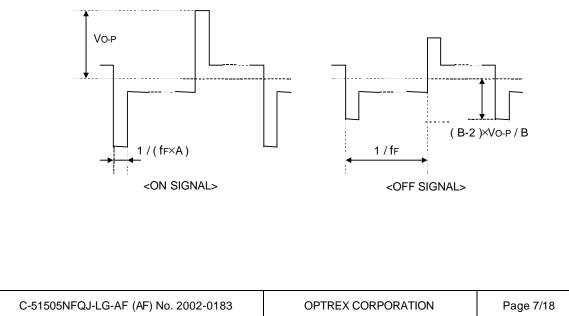
Measuring Spot:0.9mm

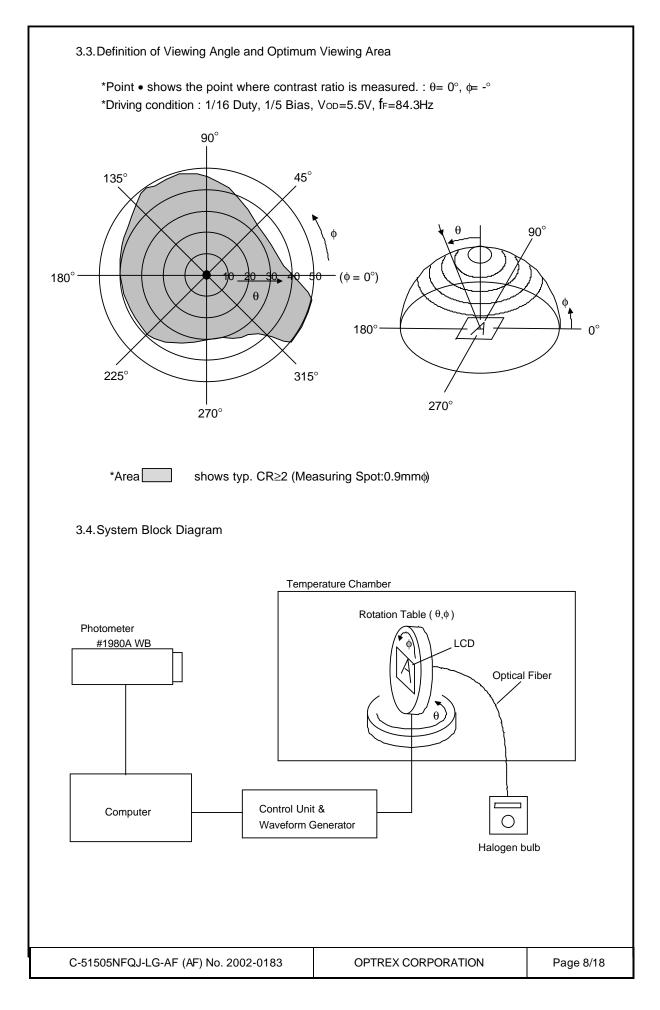
Note 2 :The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.

Note 3 :The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

Note 4 :Definition of Driving Voltage VoD

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage VoD is definded as the voltage VO-P when the contrast ratio (CR=LON / LOFF) is at its maximum.





4.I/O Terminal

4.1. Pin Assignment

<u>CN1</u>

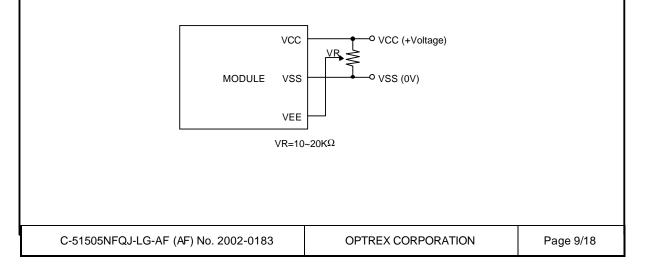
No.	Symbol	Function
1	LED (A)	LED Anode Terminal
2	LED (K)	LED Cathode Terminal
3	Vss	Power Supply (0V, GND)
4	Vcc	Power Supply for Logic
5	Vee	Power Supply for LCD Drive
6	RS	Register Select Signal
7	R/W	Read/Write Select Signal H : Read L : Write
8	E	Enable Signal (No pull-up Resister)
9	DB0	Data Bus Line / Non-connection at 4-bit operation
10	DB1	Data Bus Line / Non-connection at 4-bit operation
11	DB2	Data Bus Line / Non-connection at 4-bit operation
12	DB3	Data Bus Line / Non-connection at 4-bit operation
13	DB4	Data Bus Line
14	DB5	Data Bus Line
15	DB6	Data Bus Line
16	DB7	Data Bus Line

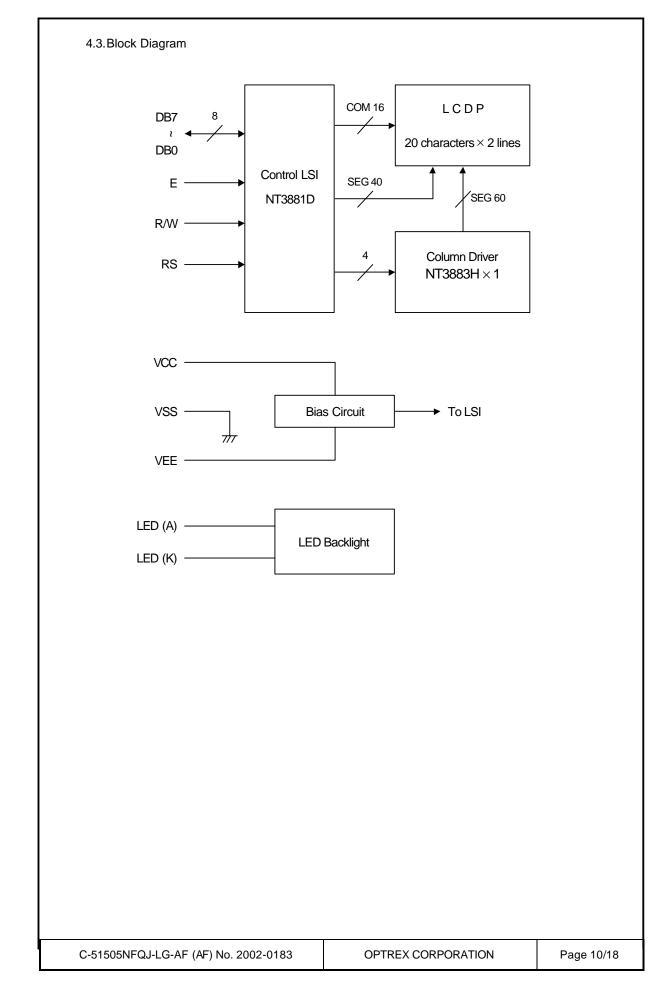
<u>CN2</u>

No.	Symbol	Function
1	LED (A)	LED Anode Terminal
2	LED (K)	LED Cathode Terminal

4.2. Example of Power Supply

It is recommended to apply a potentiometer for the contrast adjust due to the tolerance of the driving voltage and its temperature dependence.





<u>5.Test</u>

No change on display and in operation under the following test condition.

Conditions: Unless otherwise specified, tests will be conducted under the following condition. Temperature: 20±5°C Humidity : 65±5%RH tests will be not conducted under functioning state.

Parameter	Conditions	Notes
High Temperature Operating	70°C±2°C, 96hrs (operation state)	
Low Temperature Operating	-20°C±2°C, 96hrs (operation state)	1
High Temperature Storage	70°C±2°C, 96hrs	2
Low Temperature Storage	-20°C±2°C, 96hrs	1,2
Damp Proof Test	40°C±2°C,90~95%RH, 96hrs	1,2
Vibration Test	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X, Y, Z for	3
Shock Test	To be measured after dropping from 60cm high on the concrete surface in packing state. F E G G G G G G G G	
	High Temperature OperatingLow Temperature OperatingHigh Temperature StorageLow Temperature StorageDamp Proof TestVibration Test	High Temperature Operating $70^{\circ}C\pm 2^{\circ}C$, 96hrs (operation state)Low Temperature Operating $-20^{\circ}C\pm 2^{\circ}C$, 96hrs (operation state)High Temperature Storage $70^{\circ}C\pm 2^{\circ}C$, 96hrsLow Temperature Storage $-20^{\circ}C\pm 2^{\circ}C$, 96hrsDamp Proof Test $40^{\circ}C\pm 2^{\circ}C$, 90~95%RH, 96hrsVibration TestTotal fixed amplitude : 1.5mmVibration TestTotal fixed amplitude : 1.5mmVibration Frequency : 10~55HzOne cycle 60 seconds to 3 directions of X, Y, Z for each 15 minutesShock TestTo be measured after dropping from 60cm high on the concrete surface in packing state.Image: Dropping method comer dropping A comer : onceDropping method comer dropping B,C,D edge : once

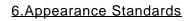
Note 1 :No dew condensation to be observed.

Note 2 :The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after removed from the test chamber.

Note 3 :Vibration test will be conducted to the product itself without putting it in a container.

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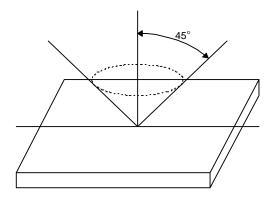


6.1. Inspection conditions

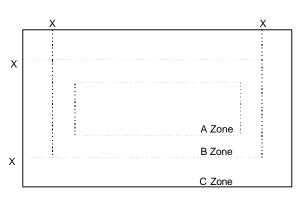
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



6.2. Definition of applicable Zones



X : Maximum Seal Line

A Zone : Active display area

B Zone : Out of active display area ~ Maximum seal line C Zone : Rest parts

A Zone + B Zone = Validity viewing area

1 The Shape of Dot (1) Pin Hole Dimension Acceptable Number 0 0 0 0 0 0 10 < D \leq 0.15 1 pc / dot(only segment)or le 0 0 0 1 pc / dot(only segment)or less (2) Pattern Shift A B $ A - B \leq 0.15$ Image: segment se	No.	Parameter			Crite) / 2 * : Disregar ria		
$\begin{array}{ c c c c c } \hline \hline & $	1	The Shape of Dot	(1) Pin Hole					
$\begin{array}{c c c c c c } \hline D \leq 0.10 & 1 \ \text{pc} \ / \ \text{dot}(\text{only segment})\text{or les} \\ \hline 0.10 < D \leq 0.15 & 1 \ \text{pc} \ / \ \text{dot}(\text{only segment})\text{or les} \\ \hline 0.10 < D \leq 0.15 & 1 \ \text{pc} \ / \ \text{cell or less} \\ \hline \end{array}$ $(2) \ \text{Pattern Shift}$ $(3) \ \text{Breakage or Chips / Deformation}$ $\begin{array}{c c c c c c c c c c c c c c c c c c c $			1	Dimensio	n	Acceptable	Number	
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(3) Breakage or Chips / Deformation (3) Breakage or Chips / Deformation 1.Segment Type Dimension Acceptable Number A ≤ 0.10 \times B ≤ 0.10 \times 2.Dot Type Dimension Acceptable Number A ≤ 0.10 \times B ≤ 0.10 \times (Should not be connected to next do 1 pc / dot(only segment)or less (Should not be connected to next do B ≤ 0.10 \times 3.Defective type extends over multiple numbers of dots Dimension Acceptable Number $d = 0.10$ \times 3.Defective type extends over multiple numbers of dots Dimension Acceptable Number Disc. 10 \times 1 pc / dot(only segment)or less 2 pcs / cell or less (ndividual dot must secure 1/2 area								
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	0 545	505NFQJ-LG-AF (AF) No	2002-0183	OPTRE	X CORI	PORATION	Page 13/	

No.	Parameter		(Criteria			
2	Black and	(1) Round Shape					
	White Spots,		Zone	Acce	ptable Nur	nber	
	Foreign Substances	Dimension		А	В	С	
			$D \leq 0.10$	*	*	*	
		0.10<	D ≤ 0.20	6	6	*	
		0.20<	0.20< D ≤ 0.30 2 2				
		Individual dot must secure 1/2 area or more. (2) Line Shape					
			Zone	Acce	ptable Nur	nber	
		Length	Width	A	В	С	
		L ≤2.0	W≤0.03	*	*	*	
		L ≤2.0	0.03 <w≤0.05< td=""><td>4</td><td>4</td><td>*</td></w≤0.05<>	4	4	*	
		*	0.05 <w< td=""><td>In the sam</td><td>e way (1)</td><td>*</td></w<>	In the sam	e way (1)	*	
			n 7pcs as total. mplex Foreign Su	ubstance Defe	ects")		
3	Color Variation	Not to be cons	picuous defects.				
4	Air Bubbles						
	(between glass	Zone Acceptable Number					
	& polarizer)	Dimension		А	В	С	
			D ≤ 0.15	*	*	*	
		0.15< D ≤ 0.30 2 3				*	
		0.30<	D ≤ 0.50	1	2	*	
		0.50<	D ≤ 1.00	0	1	*	
			ore than 3pcs as total. r to "Complex Foreign Substance Defects")				
5	Polarizer Scratches	Not to be cons	picuous defects.				
6	Polarizer Dirts	If the stains are removed easily from LCDP surface, the module is not defective.					
7	Complex Foreign Substance Defects	Black spots, line shaped foreign substances or air bubbles between glass & polarizer should be 7pcs maximum in total.					
8	Distance between Different Foreign Substance Defects	20mm or more					
					_		

No.	Parameter		- (1	Crit			rd Units : mm
9	Chipped Glass	(1) Other that	n electrode			areas	
		"Δ" siz	e:0.82or m	ore	"Δ" size	م.ا موم ا	than 0.82
		X	Y	Z	X	Y	Z
		*	<u>≤</u> 0.4	*	*	 ≤0.3	
		≤2.5	≤0.7	=t	≤2.0	≤0.5	
		≤3.5	≤1.0	≤1/2t	≤3.0	≤0.5	5 ≤1/2t
		≤5.5	≤1.5	≤1/3t	≤4.5	≤1.2	2 ≤1/3t
		(2) Corner An 1.Lead A			"^" oit		"A" size
		X		Y/	"A" siz		Less than 0.82
			\sim			X+Y X+Y ≤4.0 ≤3.0	
		2.Other the		ode pad Area	"A" siz 0.82or r	nore	"A" size Less than 0.82
			\mathbf{V}		X+Y ≤3.0		X+Y ≤2.0
			glass sha	ll be judged	defects sha only from th	all be up ne size	

7.Code System of Production Lot		
The production lot of module is specifi	ed as follows.	
Produc	 Factory Number (Numeral) Factory Code (Alphabet) tion Week (1~5) lonth (1~9, X, Y, Z) ver 2 digits) 	
8.Type Number		
The type number of module is specifie	d as follows.	
C-51505NFQJ-LG-AF		
9.Applying Precautions		
Please contact us when questions and specificationsarise.	d/or new problems not specified in this	
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10.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
- 1. The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
- 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
- 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
- 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
- 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
- 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
- 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
- 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
- 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
- 8) For models which use touch panels:
- 1. Do not stack up modules since they can be damaged by components on neighboring modules.
- 2. Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG,TAB,or COF:
 - 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear.
 - Be sure to protect the rear of the IC chip from external forces.
 - 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

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10)Models which use flexible cable, heat seal, or TAB:

- 1. In order to maintain reliability, do not touch or hold by the connector area.
- 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11) In case of buffer material such as cushion / gasket is assembled into LCD module, it may have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials.
 Descent shark and evaluate these materials.

Please check and evaluate these materials carefully before use.

12)In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film.. Please check and evaluate those acrylic materials carefully before use.

11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 3. We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary according to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- 6. Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe delivery which ever comes later.

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